74LVC2T45-Q100; **74LVCH2T45-Q100** Dual supply translating transceiver; 3-state

Rev. 1 — 22 February 2013

Product data sheet

General description 1.

The 74LVC2T45-Q100; 74LVCH2T45-Q100 are dual bit, dual supply translating transceivers with 3-state outputs that enable bidirectional level translation. They feature two 2-bits input-output ports (nA and nB), a direction control input (DIR) and dual supply pins ($V_{CC(A)}$ and $V_{CC(B)}$). Both $V_{CC(A)}$ and $V_{CC(B)}$ can be supplied with any voltage between 1.2 V and 5.5 V. This feature makes the device suitable for translating between any of the low voltage nodes (1.2 V, 1.5 V, 1.8 V, 2.5 V, 3.3 V and 5.0 V). Pins nA and DIR are referenced to V_{CC(A)} and pins nB are referenced to V_{CC(B)}. A HIGH on DIR allows transmission from nA to nB and a LOW on DIR allows transmission from nB to nA.

The devices are fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing any damaging backflow current through the device when it is powered down. In suspend mode when either $V_{CC(A)}$ or $V_{CC(B)}$ are at GND level, both A port and B port are in the high-impedance OFF-state.

Active bus hold circuitry in the 74LVCH2T45-Q100 holds unused or floating data inputs at a valid logic level.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

Features and benefits 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Wide supply voltage range:
 - V_{CC(A)}: 1.2 V to 5.5 V
 - V_{CC(B)}: 1.2 V to 5.5 V
- High noise immunity
- Complies with JEDEC standards:
 - JESD8-7 (1.2 V to 1.95 V)
 - JESD8-5 (1.8 V to 2.7 V)
 - JESD8C (2.7 V to 3.6 V)
 - JESD36 (4.5 V to 5.5 V)
- ESD protection:
 - MIL-STD-883, method 3015 Class 3A exceeds 4000 V
 - HBM JESD22-A114F Class 3A exceeds 4000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)



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- Maximum data rates:
 - 420 Mbps (3.3 V to 5.0 V translation)
 - 210 Mbps (translate to 3.3 V))
 - 140 Mbps (translate to 2.5 V)
 - ◆ 75 Mbps (translate to 1.8 V)
 - ◆ 60 Mbps (translate to 1.5 V)
- Suspend mode
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- ± 24 mA output drive (V_{CC} = 3.0 V)
- Inputs accept voltages up to 5.5 V
- Low power consumption: 16 μA maximum I_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options

3. Ordering information

Table 1.Ordering information

Type number	Package		ckage								
	Temperature range	Name	Description	Version							
74LVC2T45DC-Q100	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package;	SOT765-1							
74LVCH2T45DC-Q100			8 leads; body width 2.3 mm								

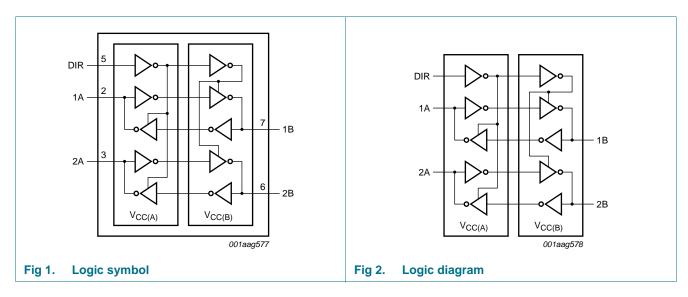
4. Marking

Table 2. Marking	
Type number	Marking code ^[1]
74LVC2T45DC-Q100	V45
74LVCH2T45DC-Q100	X45

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

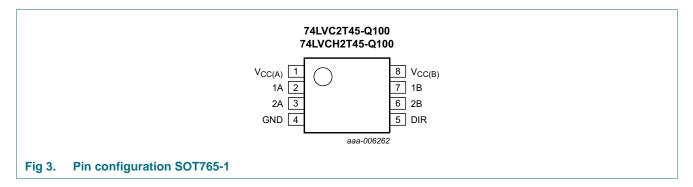
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5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
V _{CC(A)}	1	supply voltage A (port A and DIR)
1A	2	data input or output
2A	3	data input or output
GND	4	ground (0 V)
DIR	5	direction control
2B	6	data input or output
1B	7	data input or output
V _{CC(B)}	8	supply voltage B (port B)

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7. Functional description

Table 4. Function table	[1]				
Supply voltage Input Input/output ^[2]					
V _{CC(A)} , V _{CC(B)}	DIR	nA	nB		
1.2 V to 5.5 V	L	nA = nB	input		
1.2 V to 5.5 V	Н	input	nB = nA		
GND ^[3]	Х	Z	Z		

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

The input circuit of the data I/O is always active. [2]

[3] When either $V_{CC(A)}$ or $V_{CC(B)}$ is at GND level, the device goes into suspend mode.

Limiting values 8.

Table 5. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			-		
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		-0.5	+6.5	V
V _{CC(B)}	supply voltage B		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode	<u>[1][2][3]</u> –0.5	V _{CCO} + 0.5	V
		Suspend or 3-state mode	<u>[1]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V \text{ to } V_{CCO}$	[2] _	±50	mA
I _{CC}	supply current	I _{CC(A)} or I _{CC(B)}	-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[4] _	250	mW
-					

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] V_{CCO} + 0.5 V should not exceed 6.5 V.

For VSSOP8 packages: above 110 °C the value of Ptot derates linearly with 8.0 mW/K. [4]

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9. Recommended operating conditions

Table 6.	Recommended operating condit	ions			
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC(A)}	supply voltage A		1.2	5.5	V
V _{CC(B)}	supply voltage B		1.2	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage	Active mode	<u>[1]</u> 0	V _{cco}	V
		Suspend or 3-state mode	0	5.5	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CCI} = 1.2 V	[2] _	20	ns/V
		V _{CCI} = 1.4 V to 1.95 V	-	20	ns/V
		V_{CCI} = 2.3 V to 2.7 V	-	20	ns/V
		$V_{CCI} = 3 V \text{ to } 3.6 V$	-	10	ns/V
		$V_{CCI} = 4.5 V$ to 5.5 V	-	5	ns/V

[1] V_{CCO} is the supply voltage associated with the output port.

[2] V_{CCI} is the supply voltage associated with the input port.

10. Static characteristics

Table 7. Typical static characteristics at $T_{amb} = 25 \text{ °C}$

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Parameter	Conditions	Min	Тур	Max	Unit
HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
	$I_0 = -3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	<u>[1]</u> _	1.09	-	V
LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
	$I_0 = 3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$	<u>[1]</u> _	0.07	-	V
input leakage current	DIR input; $V_1 = 0$ V to 5.5 V; $V_{CCI} = 1.2$ V to 5.5 V	[2] _	-	±1	μA
bus hold LOW current	A or B port; V_I = 0.42 V; V_{CCI} = 1.2 V	[2] _	19	-	μA
bus hold HIGH current	A or B port; V_I = 0.78 V; V_{CCI} = 1.2 V	[2] _	-19	-	μA
bus hold LOW overdrive current	A or B port; $V_{CCI} = 1.2 V$	<u>[2][3]</u> _	19	-	μA
bus hold HIGH overdrive current	A or B port; $V_{CCI} = 1.2 V$	<u>[2][3]</u> _	-19	-	μA
OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	<u>[1]</u> -	-	±1	μA
power-off leakage current	A port; V ₁ or V ₀ = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V	-	-	±1	μA
	B port; V ₁ or V ₀ = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V	-	-	±1	μA
input capacitance	DIR input; $V_I = 0 V \text{ or } 3.3 V$; $V_{CC(A)} = V_{CC(B)} = 3.3 V$	-	2.2	-	pF
input/output capacitance	A and B port; suspend mode; V _O = 3.3 V or 0 V; V _{CC(A)} = V _{CC(B)} = 3.3 V	-	6.0	-	pF
	HIGH-level output voltage LOW-level output voltage input leakage current bus hold LOW current bus hold HIGH current bus hold HIGH overdrive current OFF-state output current power-off leakage current	$\begin{array}{ll} \mbox{HIGH-level output voltage} & \begin{tabular}{ l $	$\begin{array}{llllllllllllllllllllllllllllllllllll$	HIGH-level output voltage $V_1 = V_{IH}$ or V_{IL} I I $I_0 = -3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$ [1] - 1.09 LOW-level output voltage $V_1 = V_{IH}$ or V_{IL} $I_0 = 3 \text{ mA}; V_{CCO} = 1.2 \text{ V}$ [1] - 0.07 input leakage current DIR input; $V_1 = 0 \text{ V to 5.5 V};$ [2] - - bus hold LOW current A or B port; $V_1 = 0.42 \text{ V}; V_{CCI} = 1.2 \text{ V}$ [2] - -19 bus hold LOW overdrive current A or B port; $V_1 = 0.78 \text{ V}; V_{CCI} = 1.2 \text{ V}$ [2] - -19 bus hold LOW overdrive current A or B port; $V_{CCI} = 1.2 \text{ V}$ [2] - -19 bus hold HIGH overdrive current A or B port; $V_{CCI} = 1.2 \text{ V}$ [2] - -19 bus hold HIGH overdrive current A or B port; $V_{CCI} = 1.2 \text{ V}$ [2] - -19 OFF-state output current A or B port; $V_{CCI} = 1.2 \text{ V}$ [2] - -19 OFF-state output current A or B port; $V_0 = 0 \text{ V or } V_{CCO};$ [1] - - power-off leakage current A port; $V_1 \text{ or } V_0 = 0 \text{ V to 5.5 V;$ - - power-off leakage current B port; $V_1 \text{ or } V_0 = 0 \text{ V to 5.5 V;}$ - - -	HIGH-level output voltage $V_1 = V_{IH}$ or V_{IL} Io -3 mA; $V_{CCO} = 1.2$ V [1] $ 1.09$ $-$ LOW-level output voltage $V_1 = V_{IH}$ or V_{IL} $I_0 = 3$ mA; $V_{CCO} = 1.2$ V [1] $ 0.07$ $-$ input leakage current DIR input; $V_1 = 0$ V to 5.5 V; [2] $ \pm 1$ bus hold LOW current A or B port; $V_1 = 0.42$ V; $V_{CCI} = 1.2$ V [2] $ \pm 1$ bus hold LOW overdrive current A or B port; $V_1 = 0.78$ V; $V_{CCI} = 1.2$ V [2] $ -19$ $-$ bus hold LOW overdrive current A or B port; $V_{CCI} = 1.2$ V [2] $ -19$ $-$ bus hold LOW overdrive current A or B port; $V_{CCI} = 1.2$ V [2] $ -19$ $-$ bus hold HIGH overdrive current A or B port; $V_{CCI} = 1.2$ V [2] $ -19$ $-$ bus hold HIGH overdrive current A or B port; $V_{CCI} = 1.2$ V [2] $ -19$ $-$ bus hold HIGH overdrive current A or B port; $V_{CCI} = 0$ V or V_{CCO} ; -11 $ \pm 1$ $ \pm 1$ power-off leakage c

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- [1] V_{CCO} is the supply voltage associated with the output port.
- [2] $~V_{CCI}$ is the supply voltage associated with the data input port.
- [3] To guarantee the node switches, an external driver must source/sink at least IBHLO/IBHHO when the input is in the range VIL to VIH.

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		–40 °C to	o +85 °C	–40 °C to	+125 °C	Unit
				Min	Max	Min	Max	
V _{IH}	HIGH-level	data input	<u>[1]</u>					
	input voltage	V _{CCI} = 1.2 V		0.8V _{CCI}	-	0.8V _{CCI}	-	V
		V _{CCI} = 1.4 V to 1.95 V		0.65V _{CCI}	-	$0.65V_{CCI}$	-	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	-	1.7	-	V
		$V_{CCI} = 3.0 V \text{ to } 3.6 V$		2.0	-	2.0	-	V
		$V_{CCI} = 4.5 \text{ V to } 5.5 \text{ V}$		0.7V _{CCI}	-	0.7V _{CCI}	-	V
		DIR input						
		V _{CCI} = 1.2 V		0.8V _{CC(A)}	-	0.8V _{CC(A)}	-	V
		V _{CCI} = 1.4 V to 1.95 V		0.65V _{CC(A)}	-	0.65V _{CC(A)}	-	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	-	1.7	-	V
		$V_{CCI} = 3.0 V \text{ to } 3.6 V$		2.0	-	2.0	-	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		0.7V _{CC(A)}	-	0.7V _{CC(A)}	-	V
VIL	LOW-level	data input	<u>[1]</u>					
	input voltage	V _{CCI} = 1.2 V		-	0.2V _{CCI}	-	0.2V _{CCI}	V
		V _{CCI} = 1.4 V to 1.95 V		-	0.35V _{CCI}	-	$0.35V_{CCI}$	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 V \text{ to } 3.6 V$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		-	0.3V _{CCI}	-	0.3V _{CCI}	V
		DIR input						
		V _{CCI} = 1.2 V		-	0.2V _{CC(A)}	-	0.2V _{CC(A)}	V
		V _{CCI} = 1.4 V to 1.95 V		-	0.35V _{CC(A)}	-	0.35V _{CC(A)}	V
		$V_{CCI} = 2.3 \text{ V to } 2.7 \text{ V}$		-	0.7	-	0.7	V
		$V_{CCI} = 3.0 V \text{ to } 3.6 V$		-	0.8	-	0.8	V
		$V_{CCI} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$		-	0.3V _{CC(A)}	-	0.3V _{CC(A)}	V
√он	HIGH-level	$V_{I} = V_{IH}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CCO} = 1.2 \ V \text{ to } 4.5 \ V$	[2]	$V_{CCO}-0.1$	-	$V_{CCO}-0.1$	-	V
		$I_0 = -6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		1.0	-	1.0	-	V
		$I_{O} = -8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		1.2	-	1.2	-	V
		$I_{O} = -12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		1.9	-	1.9	-	V
		$I_0 = -24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		2.4	-	2.4	-	V
		$I_0 = -32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		3.8	-	3.8	-	V

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Symbol	Parameter	Conditions		–40 °C t	o +85 °C	-40 °C to	+125 °C	Uni
				Min	Max	Min	Max	
V _{OL}	LOW-level	$V_I = V_{IL}$	[2]					
	output voltage	I _O = 100 μA; V _{CCO} = 1.2 V to 4.5 V		-	0.1	-	0.1	V
		$I_0 = 6 \text{ mA}; V_{CCO} = 1.4 \text{ V}$		-	0.3	-	0.3	V
		$I_0 = 8 \text{ mA}; V_{CCO} = 1.65 \text{ V}$		-	0.45	-	0.45	V
		$I_0 = 12 \text{ mA}; V_{CCO} = 2.3 \text{ V}$		-	0.3	-	0.3	V
		$I_{O} = 24 \text{ mA}; V_{CCO} = 3.0 \text{ V}$		-	0.55	-	0.55	V
		$I_{O} = 32 \text{ mA}; V_{CCO} = 4.5 \text{ V}$		-	0.55	-	0.55	V
I	input leakage current	DIR input; $V_I = 0 V$ to 5.5 V; $V_{CCI} = 1.2 V$ to 5.5 V		-	±2	-	±10	μA
BHL	bus hold LOW	A or B port	<u>[1]</u>					
	current	$V_{I} = 0.49 \text{ V}; V_{CCI} = 1.4 \text{ V}$		15	-	10	-	μΑ
		$V_{I} = 0.58 \text{ V}; V_{CCI} = 1.65 \text{ V}$		25	-	20	-	μA
		$V_{I} = 0.70 \text{ V}; V_{CCI} = 2.3 \text{ V}$		45	-	45	-	μA
		$V_{I} = 0.80 \text{ V}; V_{CCI} = 3.0 \text{ V}$		100	-	80	-	μA
		$V_{I} = 1.35 \text{ V}; V_{CCI} = 4.5 \text{ V}$		100	-	100	-	μA
	bus hold HIGH	A or B port	[1]					
	current	$V_{I} = 0.91 \text{ V}; V_{CCI} = 1.4 \text{ V}$		-15	-	-10	-	μA
		$V_{I} = 1.07 \text{ V}; V_{CCI} = 1.65 \text{ V}$		-25	-	-20	-	μA
		$V_{I} = 1.60 \text{ V}; V_{CCI} = 2.3 \text{ V}$		-45	-	-45	-	μA
		$V_{I} = 2.00 \text{ V}; V_{CCI} = 3.0 \text{ V}$		-100	-	-80	-	μA
		$V_{I} = 3.15 \text{ V}; V_{CCI} = 4.5 \text{ V}$		-100	-	-100	-	μA
BHLO	bus hold LOW	A or B port	<u>[1][3]</u>					
	overdrive current	$V_{CCI} = 1.6 V$		125	-	125	-	μA
	ourront	V _{CCI} = 1.95 V		200	-	200	-	μA
		$V_{CCI} = 2.7 V$		300	-	300	-	μA
		$V_{CCI} = 3.6 V$		500	-	500	-	μA
		$V_{CCI} = 5.5 V$		900	-	900	-	μA
внно	bus hold HIGH	A or B port	<u>[1][3]</u>					
	overdrive current	$V_{CCI} = 1.6 V$		-125	-	-125	-	μA
	carroin	V _{CCI} = 1.95 V		-200	-	-200	-	μA
		$V_{CCI} = 2.7 V$		-300	-300300 -	-	μA	
		V _{CCI} = 3.6 V		-500	-	-500	-	μA
		V _{CCI} = 5.5 V		-900	-	-900	-	μA
OZ	OFF-state output current	A or B port; $V_0 = 0$ V or V_{CCO} ; $V_{CCO} = 1.2$ V to 5.5 V	[2]	-	±2	-	±10	μA

Table 8. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

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Symbol	Parameter	Conditions		–40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
				Min	Max	Min	Max	
I _{OFF}	power-off leakage current	A port; V ₁ or V ₀ = 0 V to 5.5 V; V _{CC(A)} = 0 V; V _{CC(B)} = 1.2 V to 5.5 V		-	±2	-	±10	μA
		B port; V ₁ or V ₀ = 0 V to 5.5 V; V _{CC(B)} = 0 V; V _{CC(A)} = 1.2 V to 5.5 V		-	±2	-	±10	μA
I _{CC}	supply current	A port; $V_I = 0 V \text{ or } V_{CCI}$; $I_O = 0 A$	[1]					
		$V_{CC(A)}$, $V_{CC(B)} = 1.2$ V to 5.5 V		-	8	-	8	μA
		$V_{CC(A)}$, $V_{CC(B)} = 1.65$ V to 5.5 V		-	3	-	3	μA
		$V_{CC(A)} = 5.5 \text{ V}; V_{CC(B)} = 0 \text{ V}$		-	2	-	2	μA
		$V_{CC(A)} = 0 V; V_{CC(B)} = 5.5 V$		-2	-	-2	-	μA
		B port; $V_I = 0 V$ or V_{CCI} ; $I_O = 0 A$						
		$V_{CC(A)}$, $V_{CC(B)} = 1.2$ V to 5.5 V		-	8	-	8	μA
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.65 V to 5.5 V		-	3	-	3	μA
		$V_{CC(B)} = 0 V; V_{CC(A)} = 5.5 V$		-2	-	-2	-	μA
		$V_{CC(B)} = 5.5 \text{ V}; V_{CC(A)} = 0 \text{ V}$		-	2	-	2	μA
		A plus B port ($I_{CC(A)} + I_{CC(B)}$); $I_O = 0$ A; $V_I = 0$ V or V_{CCI}						
		$V_{CC(A)}$, $V_{CC(B)} = 1.2$ V to 5.5 V		-	16	-	16	μA
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.65 V to 5.5 V		-	4	-	4	μA
ΔI_{CC}	additional supply current	per input; $V_{CC(A)}$, $V_{CC(B)}$ = 3.0 V to 5.5 V						
		A port; A port at $V_{CC(A)} - 0.6$ V; DIR at $V_{CC(A)}$; B port = open	<u>[4]</u>	-	50	-	75	μΑ
		DIR input; DIR at $V_{CC(A)} - 0.6$ V; A port at $V_{CC(A)}$ or GND; B port = open		-	50	-	75	μA
		B port; B port at $V_{CC(B)} - 0.6$ V; DIR at GND; A port = open	<u>[4]</u>	-	50	-	75	μΑ

Table 8. Static characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO}/I_{BHHO} when the input is in the range V_{IL} to V_{IH} .

[4] For non-bus hold parts only (74LVC2T45-Q100).

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11. Dynamic characteristics

Table 9. Typical dynamic characteristics at $V_{CC(A)} = 1.2$ V and $T_{amb} = 25$ °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6; for waveforms see Figure 4 and Figure 5.

Symbol	Parameter	Conditions			Vc	C(B)			Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{PLH}	LOW to HIGH	A to B	10.6	8.1	7.0	5.8	5.3	5.1	ns
	propagation delay	B to A	10.6	9.5	9.0	8.5	8.3	8.2	ns
t _{PHL}	HIGH to LOW	A to B	10.1	7.1	6.0	5.3	5.2	5.4	ns
F	propagation delay	B to A	10.1	8.6	8.1	7.8	7.6	7.6	ns
1112	HIGH to OFF-state	DIR to A	9.4	9.4	9.4	9.4	9.4	9.4	ns
	propagation delay	DIR to B	12.0	9.4	9.0	7.8	8.4	7.9	ns
t _{PLZ}	LOW to OFF-state	DIR to A	7.1	7.1	7.1	7.1	7.1	7.1	ns
	propagation delay	DIR to B	9.5	7.8	7.7	6.9	7.6	7.0	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	20.1	17.3	16.7	15.4	15.9	15.2	ns
	propagation delay	DIR to B	17.7	15.2	14.1	12.9	12.4	12.2	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	22.1	18.0	17.1	15.6	16.0	15.5	ns
pro	propagation delay	DIR to B [1]	19.5	16.5	15.4	14.7	14.6	14.8	ns

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times".

Table 10. Typical dynamic characteristics at $V_{CC(B)} = 1.2$ V and $T_{amb} = 25$ °C

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 6</u>; for waveforms see <u>Figure 4</u> and <u>Figure 5</u>.

Symbol	Parameter	Conditions			Vc	C(A)			Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t _{PLH}	LOW to HIGH	A to B	10.6	9.5	9.0	8.5	8.3	8.2	ns
	propagation delay	B to A	10.6	8.1	7.0	5.8	5.3	5.1	ns
t _{PHL}	HIGH to LOW	A to B	10.1	8.6	8.1	7.8	7.6	7.6	ns
propaga	propagation delay	B to A	10.1	7.1	6.0	5.3	5.2	5.4	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	9.4	6.5	5.7	4.1	4.1	3.0	ns
	propagation delay	DIR to B	12.0	6.1	5.4	4.6	4.3	4.0	ns
t _{PLZ}	LOW to OFF-state	DIR to A	7.1	4.9	4.5	3.2	3.4	2.5	ns
	propagation delay	DIR to B	9.5	7.3	6.6	5.9	5.7	5.6	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	20.1	15.4	13.6	11.7	11.0	10.7	ns
	propagation delay	DIR to B	17.7	14.4	13.5	11.7	11.7	10.7	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	22.1	13.2	11.4	9.9	9.5	9.4	ns
	propagation delay	DIR to B	19.5	15.1	13.8	11.9	11.7	10.6	ns

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times".

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Symbol	Parameter	Conditions		V _{CC(A)} ai	nd V _{CC(B)}		Unit
			1.8 V	2.5 V	3.3 V	5.0 V	
C _{PD} power dissipation capacitance		A port: (direction A to B); B port: (direction B to A)	2	3	3	4	pF
		A port: (direction B to A); B port: (direction A to B)	15	16	16	18	pF

Table 11. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and $T_{amb} = 25 \text{ °C}$ [1][2] *Voltages are referenced to GND (ground = 0 V).*

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 $C_L = load capacitance in pF;$

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6; for wave forms see Figure 4 and Figure 5.

Symbol	Parameter	Conditions					Vcc	;(В)					Unit
			1.5 V ±	± 0.1 V	1.8 V ±	0.15 V	2.5 V ±	E 0.2 V	3.3 V ±	± 0.3 V	5.0 V ±	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
V _{CC(A)} =	1.4 V to 1.6 V												
t _{PLH}	LOW to HIGH	A to B	2.8	21.3	2.4	17.6	2.0	13.5	1.7	11.8	1.6	10.5	ns
	propagation delay	B to A	2.8	21.3	2.6	19.1	2.3	14.9	2.3	12.4	2.2	12.0	ns
t _{PHL}	HIGH to LOW	A to B	2.6	19.3	2.2	15.3	1.8	11.8	1.7	10.9	1.7	10.8	ns
	propagation delay	B to A	2.6	19.3	2.4	17.3	2.3	13.2	2.2	11.3	2.3	11.0	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	3.0	18.7	ns
	propagation delay	DIR to B	3.5	24.8	3.5	23.6	3.0	11.0	3.3	11.3	2.8	10.3	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	2.4	11.4	ns
	propagation delay	DIR to B	2.8	18.3	3.0	17.2	2.5	9.4	3.0	10.1	2.5	9.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	39.6	-	36.3	-	24.3	-	22.5	-	21.4	ns
	propagation delay	DIR to B [1]	-	32.7	-	29.0	-	24.9	-	23.2	-	21.9	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	44.1	-	40.9	-	24.2	-	22.6	-	21.3	ns
	propagation delay	DIR to B [1]	-	38.0	-	34.0	-	30.5	-	29.6	-	29.5	ns
$V_{CC(A)} =$	1.65 V to 1.95 V												
t _{PLH}	LOW to HIGH	A to B	2.6	19.1	2.2	17.7	2.2	9.3	1.7	7.2	1.4	6.8	ns
	propagation delay	B to A	2.4	17.6	2.2	17.7	2.3	16.0	2.1	15.5	1.9	15.1	ns
t _{PHL}	HIGH to LOW	A to B	2.4	17.3	2.0	14.3	1.6	8.5	1.8	7.1	1.7	7.0	ns
	propagation delay	B to A	2.2	15.3	2.0	14.3	2.1	12.9	2.0	12.6	1.8	12.2	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	2.9	17.1	ns
	propagation delay	DIR to B	3.2	24.1	3.2	21.9	2.7	11.5	3.0	10.3	2.5	8.2	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	2.4	10.5	ns
	propagation delay	DIR to B	2.5	17.6	2.6	16.0	2.2	9.2	2.7	8.4	2.4	7.1	ns

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Symbol	Parameter	Condition	S					Vcc	C(B)					Un
-				1.5 V	± 0.1 V	1.8 V ±	0.15 V	1		3.3 V :	± 0.3 V	5.0 V :	± 0.5 V	1
				Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
PZH	OFF-state to HIGH	DIR to A	[1]	-	35.2	-	33.7	-	25.2	-	23.9	-	22.2	ns
	propagation delay	DIR to B	[1]	-	29.6	-	28.2	-	19.8	-	17.7	-	17.3	ns
t _{PZL}	OFF-state to LOW	DIR to A	[1]	-	39.4	-	36.2	-	24.4	-	22.9	-	20.4	ns
	propagation delay	DIR to B	[1]	-	34.4	-	31.4	-	25.6	-	24.2	-	24.1	ns
$V_{CC(A)} =$	2.3 V to 2.7 V													
PLH	LOW to HIGH	A to B		2.3	17.9	2.3	16.0	1.5	8.5	1.3	6.2	1.1	4.8	ns
	propagation delay	B to A		2.0	13.5	2.2	9.3	1.5	8.5	1.4	8.0	1.0	7.5	ns
PHL	HIGH to LOW	A to B		2.3	15.8	2.1	12.9	1.4	7.5	1.3	5.4	0.9	4.6	ns
	propagation delay	B to A		1.8	11.8	1.9	8.5	1.4	7.5	1.3	7.0	0.9	6.2	ns
t _{PHZ}	HIGH to OFF-state	DIR to A		2.1	8.1	2.1	8.1	2.1	8.1	2.1	8.1	2.1	8.1	ns
	propagation delay	DIR to B		3.0	22.5	3.0	21.4	2.5	11.0	2.8	9.3	2.3	6.9	ns
t _{PLZ}	LOW to OFF-state	DIR to A		1.7	5.8	1.7	5.8	1.7	5.8	1.7	5.8	1.7	5.8	ns
	propagation delay	DIR to B		2.3	14.6	2.5	13.2	2.0	9.0	2.5	8.4	1.8	5.8	ns
t _{PZH}	OFF-state to HIGH	DIR to A	[1]	-	28.1	-	22.5	-	17.5	-	16.4	-	13.3	ns
	propagation delay	DIR to B	[1]	-	23.7	-	21.8	-	14.3	-	12.0	-	10.6	ns
PZL	OFF-state to LOW	DIR to A	[1]	-	34.3	-	29.9	-	18.5	-	16.3	-	13.1	ns
	propagation delay	DIR to B	[1]	-	23.9	-	21.0	-	15.6	-	13.5	-	12.7	ns
V _{CC(A)} =	3.0 V to 3.6 V													
t _{PLH}	LOW to HIGH	A to B		2.3	17.1	2.1	15.5	1.4	8.0	0.8	5.6	0.7	4.4	ns
	propagation delay	B to A		1.7	11.8	1.7	7.2	1.3	6.2	0.7	5.6	0.6	5.4	ns
t _{PHL}	HIGH to LOW	A to B		2.2	15.6	2.0	12.6	1.3	7.0	0.8	5.0	0.7	4.0	ns
	propagation delay	B to A		1.7	10.9	1.8	7.1	1.3	5.4	0.8	5.0	0.7	4.5	ns
t _{PHZ}	HIGH to OFF-state	DIR to A		2.3	7.3	2.3	7.3	2.3	7.3	2.3	7.3	2.7	7.3	ns
	propagation delay	DIR to B		2.9	18.0	2.9	16.5	2.3	10.1	2.7	8.6	2.2	6.3	ns
t _{PLZ}	LOW to OFF-state	DIR to A		2.0	5.6	2.0	5.6	2.0	5.6	2.0	5.6	2.0	5.6	ns
	propagation delay	DIR to B		2.3	13.6	2.4	12.5	1.9	7.8	2.3	7.1	1.7	4.9	ns
t _{PZH}	OFF-state to HIGH		[1]	-	25.4	-	19.7	-	14.0	-	12.7	-	10.3	ns
	propagation delay	DIR to B	<u>[1]</u>	-	22.7	-	21.1	-	13.6	-	11.2	-	10.0	ns
t _{PZL}	OFF-state to LOW		[1]	-	28.9	-	23.6	-	15.5	-	13.6	-	10.8	ns
	propagation delay	DIR to B	[1]	-	22.9	-	19.9	-	14.3	-	12.3	-	11.3	ns
V _{CC(A)} =	4.5 V to 5.5 V													
t _{PLH}	LOW to HIGH	A to B		2.2	16.6	1.9	15.1	1.0	7.5	0.7	5.4	0.5	3.9	ns
	propagation delay	B to A		1.6	10.5	1.4	6.8	1.0	4.8	0.7	4.4	0.5	3.9	ns
t _{PHL}	HIGH to LOW	A to B		2.3	15.3	1.8	12.2	1.0	6.2	0.7	4.5	0.5	3.5	ns
	propagation delay	B to A		1.7	10.8	1.7	7.0	0.9	4.6	0.7	4.0	0.5	3.5	ns
t _{PHZ}	HIGH to OFF-state propagation delay	DIR to A		1.7	5.4	1.7	5.4	1.7	5.4	1.7	5.4	1.7	5.4	ns
	and a second second second second					2.9	16.1							

Table 12. Dynamic characteristics for temperature range –40 °C to +85 °C ...continued Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6; for wave forms see Figure 4 and Figure 5.

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Symbol	Parameter	Conditions					Vcc	;(B)					Unit
			1.5 V ±	± 0.1 V	1.8 V ±	0.15 V	2.5 V ±	E 0.2 V	3.3 V ±	E 0.3 V	5.0 V ±	- 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Мах	Min	Max	
t _{PLZ}	LOW to OFF-state	DIR to A	1.4	3.7	1.4	3.7	1.3	3.7	1.0	3.7	0.9	3.7	ns
	propagation delay	DIR to B	2.3	13.1	2.4	12.1	1.9	7.4	2.3	7.0	1.8	4.5	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	23.6	-	18.9	-	12.2	-	11.4	-	8.4	ns
	propagation delay	DIR to B [1]	-	20.3	-	18.8	-	11.2	-	9.1	-	7.6	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	28.1	-	23.1	-	14.3	-	12.0	-	9.2	ns
propagation delay	DIR to B [1]	-	20.7	-	17.6	-	11.6	-	9.9	-	8.9	ns	

Table 12. Dynamic characteristics for temperature range -40 °C to +85 °C ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6; for wave forms see Figure 4 and Figure 5.

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times".

Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6; for wave forms see Figure 4 and Figure 5.

Symbol	Parameter	Conditions					Vcc	с(В)					Unit
			1.5 V :	± 0.1 V	1.8 V ±	0.15 V	2.5 V :		3.3 V :	± 0.3 V	5.0 V ±	± 0.5 V	
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
$V_{CC(A)} =$	1.4 V to 1.6 V												
t _{PLH}	LOW to HIGH	A to B	2.5	23.5	2.1	19.4	1.8	14.9	1.5	13.0	1.4	11.6	ns
	propagation delay	B to A	2.5	23.5	2.3	21.1	2.0	16.4	2.0	13.7	1.9	13.2	ns
t _{PHL}	HIGH to LOW	A to B	2.3	21.3	1.9	16.9	1.6	13.0	1.5	12.0	1.5	11.9	ns
	propagation delay	B to A	2.3	21.3	2.1	19.1	2.0	14.6	1.9	12.5	2.0	12.1	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	2.7	20.6	ns
	propagation delay	DIR to B	3.1	27.3	3.1	26.0	2.7	12.1	2.9	12.5	2.5	11.4	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	2.1	12.6	ns
	propagation delay	DIR to B	2.5	20.2	2.7	19.0	2.2	10.4	2.7	11.2	2.2	10.4	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	43.7	-	40.1	-	26.8	-	24.9	-	23.6	ns
	propagation delay	DIR to B [1]	-	36.1	-	32.0	-	27.5	-	25.6	-	24.2	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	48.6	-	45.1	-	26.7	-	25.0	-	23.5	ns
	propagation delay	DIR to B [1]	-	41.9	-	37.5	-	33.6	-	32.6	-	32.5	ns
V _{CC(A)} =	1.65 V to 1.95 V												
t _{PLH}	LOW to HIGH	A to B	2.3	21.1	1.9	19.5	1.9	10.3	1.5	8.0	1.2	7.5	ns
	propagation delay	B to A	2.1	19.4	1.9	19.5	2.0	17.6	1.8	17.1	1.7	16.7	ns
t _{PHL}	HIGH to LOW	A to B	2.1	19.1	1.8	15.8	1.4	9.4	1.6	7.9	1.5	7.7	ns
	propagation delay	B to A	1.9	16.9	1.8	15.8	1.8	14.2	1.8	13.9	1.6	13.5	ns
t _{PHZ}	HIGH to OFF-state	DIR to A	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	2.6	18.9	ns
	propagation delay	DIR to B	2.8	26.6	2.8	24.1	2.4	12.7	2.7	11.4	2.2	9.1	ns
t _{PLZ}	LOW to OFF-state	DIR to A	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	2.1	11.6	ns
	propagation delay	DIR to B	2.2	19.4	2.3	17.6	1.9	10.2	2.4	9.3	2.1	7.9	ns
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	38.8	-	37.1	-	27.8	-	26.4	-	24.6	ns
	propagation dalay	DIR to B [1]	-	32.7	-	31.1	-	21.9	-	19.6	-	19.1	ns

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Symbol	Parameter	Condition	าร					Vcc	C(B)					Un
				1.5 V :	± 0.1 V	1.8 V ±	0.15 V	2.5 V :	± 0.2 V	3.3 V :	± 0.3 V	5.0 V ±	± 0.5 V	
				Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
PZL	OFF-state to LOW	DIR to A	[1]	-	43.5	-	39.9	-	26.9	-	25.3	-	22.6	ns
	propagation delay	DIR to B	[1]	-	38.0	-	34.7	-	28.3	-	26.8	-	26.6	ns
/ _{CC(A)} =	2.3 V to 2.7 V													
PLH	LOW to HIGH	A to B		2.0	19.7	2.0	17.6	1.3	9.4	1.1	6.9	0.9	5.3	ns
	propagation delay	B to A		1.8	14.9	1.9	10.3	1.3	9.4	1.2	8.8	0.9	8.3	ns
PHL	HIGH to LOW	A to B		2.0	17.4	1.8	14.2	1.2	8.3	1.1	6.0	0.8	5.1	ns
	propagation delay	B to A		1.6	13.0	1.7	9.4	1.2	8.3	1.1	7.7	0.8	6.9	ns
PHZ	HIGH to OFF-state	DIR to A		1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	1.8	9.0	ns
	propagation delay	DIR to B		2.7	24.8	2.7	23.6	2.2	12.1	2.5	10.3	2.0	7.6	ns
PLZ	LOW to OFF-state	DIR to A		1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	1.5	6.4	ns
	propagation delay	DIR to B		2.0	16.1	2.2	14.6	1.8	9.9	2.2	9.3	1.6	6.4	ns
PZH	OFF-state to HIGH	DIR to A	[1]	-	31.0	-	24.9	-	19.3	-	18.1	-	14.7	ns
	propagation delay	DIR to B	[1]	-	26.1	-	24.0	-	15.8	-	13.3	-	11.7	ns
PZL	OFF-state to LOW	DIR to A	[1]	-	37.8	-	33.0	-	20.4	-	18.0	-	14.5	n
	propagation delay	DIR to B	[1]	-	26.4	-	23.2	-	17.3	-	15.0	-	14.1	ns
V _{CC(A)} =	3.0 V to 3.6 V													
PLH	LOW to HIGH	A to B		2.0	18.9	1.8	17.1	1.2	8.8	0.7	6.2	0.6	4.9	n
	propagation delay	B to A		1.5	13.0	1.5	8.0	1.1	6.9	0.6	6.2	0.5	6.0	n
t _{PHL}	HIGH to LOW	A to B		1.9	17.2	1.8	13.9	1.1	7.7	0.7	5.5	0.6	4.4	n
	propagation delay	B to A		1.5	12.0	1.6	7.9	1.1	6.0	0.7	5.5	0.6	5.0	n
t _{PHZ}	HIGH to OFF-state	DIR to A		2.0	8.1	2.0	8.1	2.0	8.1	2.0	8.1	2.4	8.1	ns
	propagation delay	DIR to B		2.6	19.8	2.6	18.2	2.0	11.2	2.4	9.5	1.9	7.0	n
t _{PLZ}	LOW to OFF-state	DIR to A		1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	1.8	6.2	ns
	propagation delay	DIR to B		2.0	15.0	2.1	13.8	1.7	8.6	2.0	7.9	1.5	5.4	ns
t _{PZH}	OFF-state to HIGH propagation delay	DIR to A	[1]	-	28.0	-	21.8	-	15.5	-	14.1	-	11.4	ns
		DIR to B	[1]	-	25.1	-	23.3	-	15.0	-	12.4	-	11.1	ns
t _{PZL}	OFF-state to LOW propagation delay	DIR to A	[1]	-	31.8	-	26.1	-	17.2	-	15.0	-	12.0	ns
		DIR to B	<u>[1]</u>	-	25.3	-	22.0	-	15.8	-	13.6	-	12.5	ns
	4.5 V to 5.5 V													
PLH	LOW to HIGH propagation delay	A to B		1.9	18.3	1.7	16.7	0.9	8.3	0.6	6.0	0.4	4.3	ns
		B to A		1.4	11.6	1.2	7.5	0.9	5.3	0.6	4.9	0.4	4.3	ns
PHL	HIGH to LOW propagation delay	A to B		2.0	16.9	1.6	13.5	0.9	6.9	0.6	5.0	0.4	3.9	ns
		B to A		1.5	11.9	1.5	7.7	0.8	5.1	0.6	4.4	0.4	3.9	n
PHZ	HIGH to OFF-state	DIR to A		1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	1.5	6.0	n
	propagation delay	DIR to B		2.6	19.1	2.6	17.8	2.0	10.7	2.4	8.8	2.2	6.3	ns
t _{PLZ}	LOW to OFF-state	DIR to A		1.2	4.1	1.2	4.1	1.1	4.1	0.9	4.1	0.8	4.1	ns
	propagation delay	DIR to B		2.0	14.5	2.1	13.4	1.7	8.2	2.0	7.7	1.6	5.0	ns

Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C ...continued

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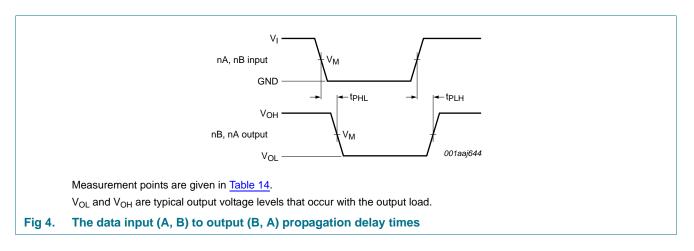
Table 13. Dynamic characteristics for temperature range -40 °C to +125 °C ...continued

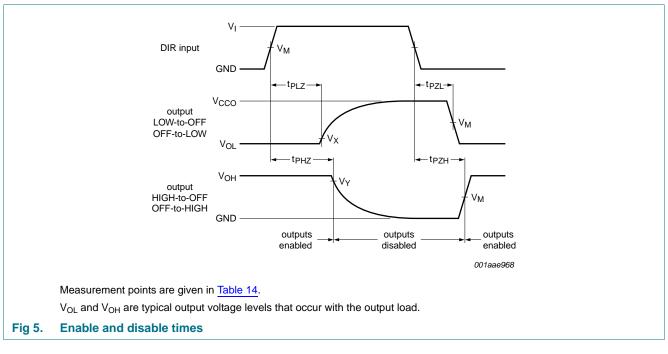
Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 6; for wave forms see Figure 4 and Figure 5.

Symbol	Parameter	Conditions					Vcc	:(В)					Unit
			1.5 V ±	± 0.1 V	1.8 V ±	0.15 V	2.5 V ±	± 0.2 V	3.3 V ±	- 0.3 V	V 5.0 V ± 0.5 V		
			Min	Max	Min	Max	Min	Мах	Min	Max	Min	Мах	
t _{PZH}	OFF-state to HIGH	DIR to A [1]	-	26.1	-	20.9	-	13.5	-	12.6	-	9.3	ns
	propagation delay	DIR to B [1]	-	22.4	-	20.8	-	12.4	-	10.1	-	8.4	ns
t _{PZL}	OFF-state to LOW	DIR to A [1]	-	31.0	-	25.5	-	15.8	-	13.2	-	10.2	ns
	propagation delay	DIR to B [1]	-	22.9	-	19.5	-	12.9	-	11.0	-	9.9	ns

[1] t_{PZH} and t_{PZL} are calculated values using the formula shown in Section 14.4 "Enable times".

12. Waveforms





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Table 14.Measurement points

Supply voltage	Input ^[1]	Output ^[2]		
V _{CC(A)} , V _{CC(B)}	V _M	V _M	V _X	V _Y
1.2 V to 1.6 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.1 V	V _{OH} – 0.1 V
1.65 V to 2.7 V	0.5V _{CCI}	0.5V _{CCO}	V _{OL} + 0.15 V	V _{OH} – 0.15 V
3.0 V to 5.5 V	0.5V _{CCI}	$0.5V_{CCO}$	V _{OL} + 0.3 V	V _{OH} – 0.3 V

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] V_{CCO} is the supply voltage associated with the output port.

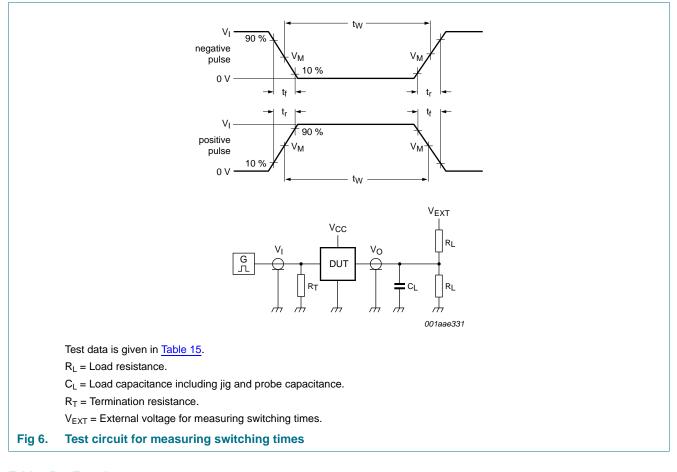


Table 15. Test data

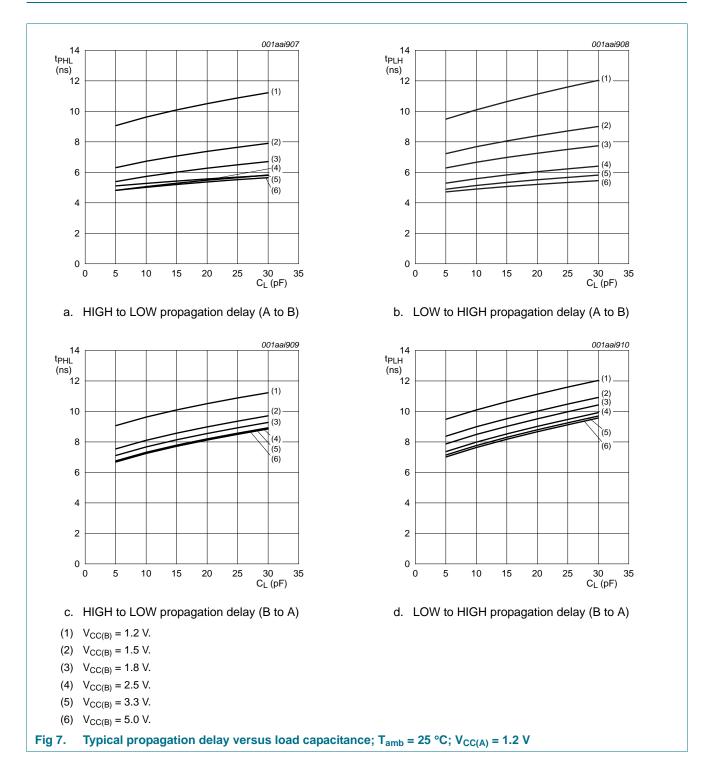
Supply voltage	Input		Load		V _{EXT}				
V _{CC(A)} , V _{CC(B)}	V _I [1]	∆t/∆V[2]	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ} [3]		
1.2 V to 5.5 V	V _{CCI}	\leq 1.0 ns/V	15 pF	2 kΩ	open	GND	2V _{CCO}		

[1] V_{CCI} is the supply voltage associated with the data input port.

[2] $dV/dt \ge 1.0$ V/ns.

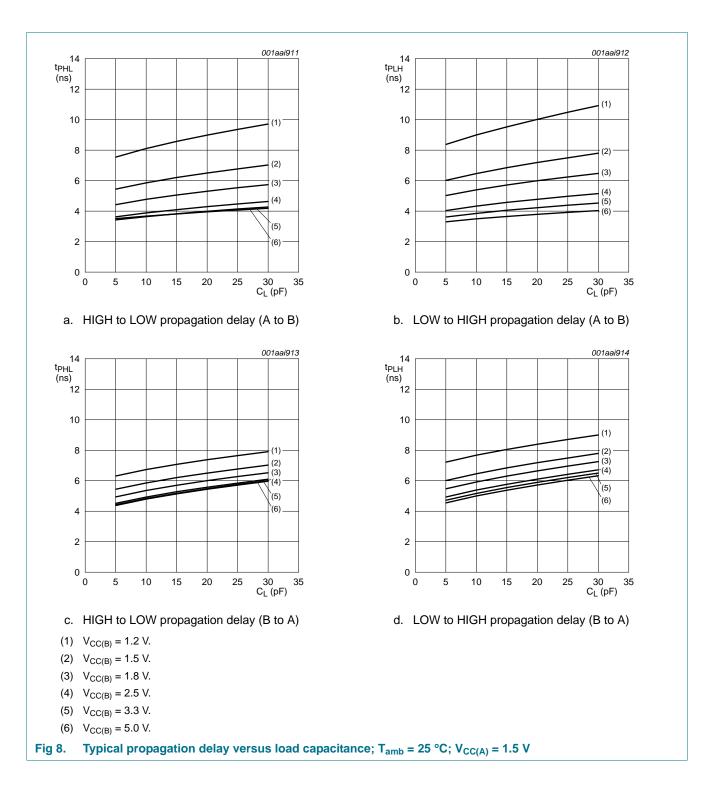
[3] V_{CCO} is the supply voltage associated with the output port.

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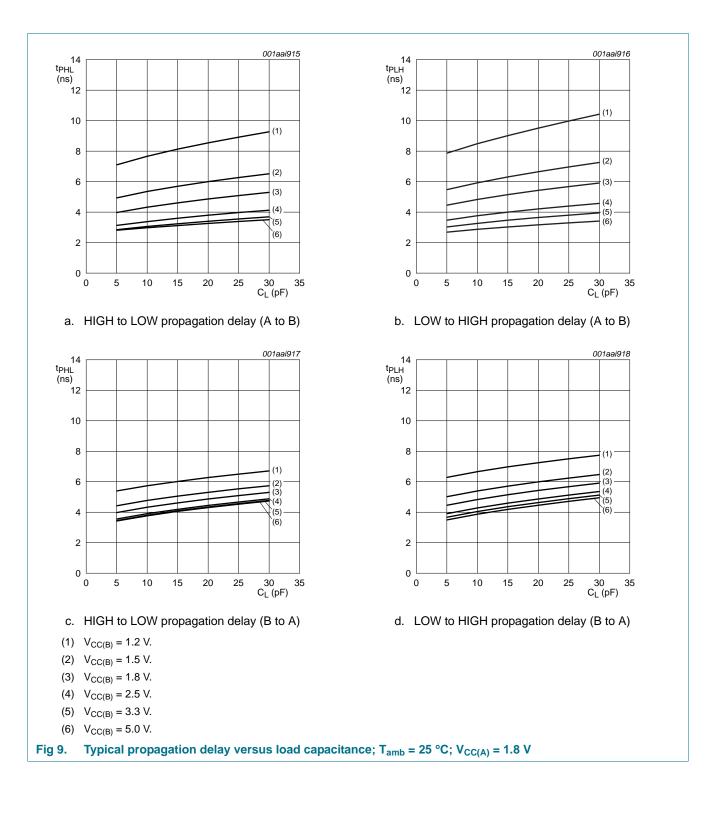
13. Typical propagation delay characteristics

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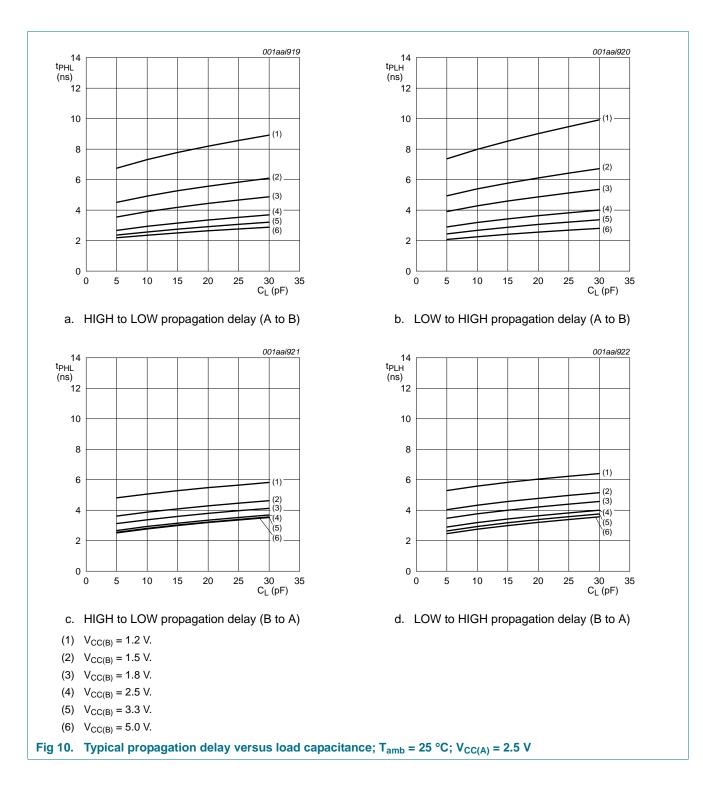


74LVC2T45-Q100; 74LVCH2T45-Q100

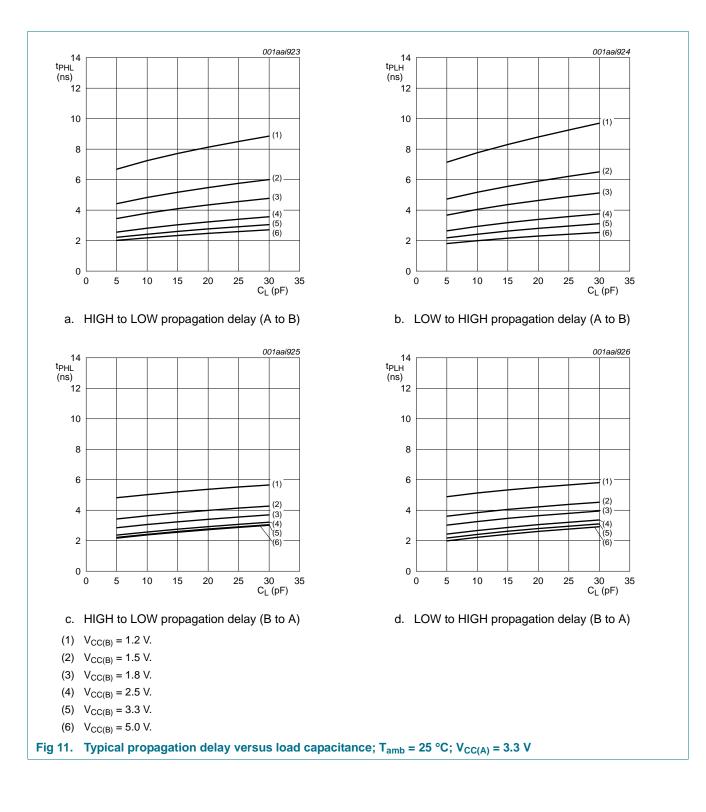
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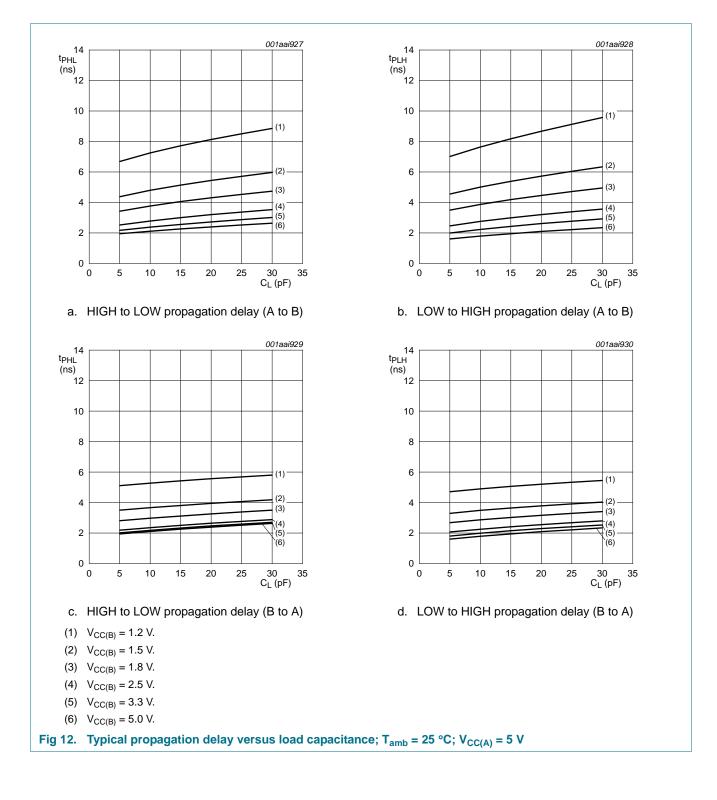
74LVC2T45-Q100; 74LVCH2T45-Q100



74LVC2T45-Q100; 74LVCH2T45-Q100



74LVC2T45-Q100; 74LVCH2T45-Q100



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14. Application information

14.1 Unidirectional logic level-shifting application

The circuit given in <u>Figure 13</u> is an example of the 74LVC2T45-Q100; 74LVCH2T45-Q100 being used in a unidirectional logic level-shifting application.

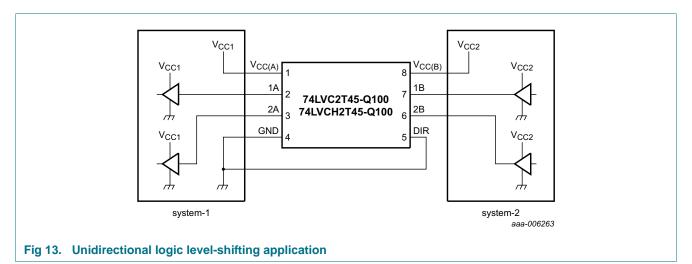


Table 16.	Description of u	unidirectional logi	c level-shifting application
Pin	Name	Function	Description
1	V _{CC(A)}	V _{CC1}	supply voltage of system-1 (1.2 V to 5.5 V)
2	1A	OUT	output level depends on V _{CC1} voltage
3	2A	OUT	output level depends on V _{CC1} voltage
4	GND	GND	device GND
5	DIR	DIR	the GND (LOW level) determines B port to A port direction
6	2B	IN	input threshold value depends on V_{CC2} voltage
7	1B	IN	input threshold value depends on V_{CC2} voltage
8	V _{CC(B)}	V _{CC2}	supply voltage of system-2 (1.2 V to 5.5 V)

14.2 Bidirectional logic level-shifting application

Figure 14 shows the 74LVC2T45-Q100; 74LVCH2T45-Q100 being used in a bidirectional logic level-shifting application. Since the device does not have an output enable pin, the system designer should take precautions to avoid bus contention between system-1 and system-2 when changing directions.

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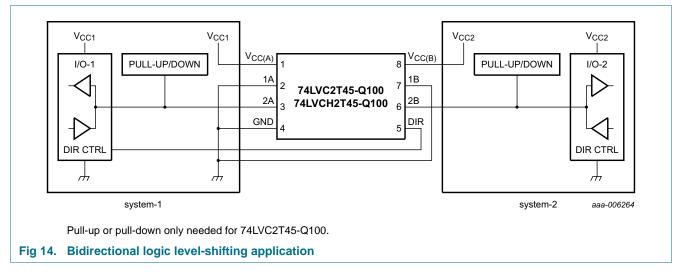


Table 17 provides a sequence that illustrates data transmission from system-1 to system-2 and then from system-2 to system-1.

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State	DIR CTRL	I/O-1	I/O-2	Description
1	Н	output	input	system-1 data to system-2
2	Н	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold
3	L	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 are still disabled. The bus-line state depends on bus hold
4	L	input	output	system-2 data to system-1

Table 17. Description of bidirectional logic level-shifting application^[1]

[1] H = HIGH voltage level;

L = LOW voltage level;

Z = high-impedance OFF-state.

14.3 Power-up considerations

The device is designed such that no special power-up sequence is required other than GND being applied first.

Table 18.	Typical total	supply current	$(I_{CC(A)} + I_{CC(B)})$
-----------	---------------	----------------	---------------------------

V _{CC(A)}	V _{CC(B)}					Unit
	0 V	1.8 V	2.5 V	3.3 V	5.0 V	
0 V	0	< 1	< 1	< 1	< 1	μΑ
1.8 V	< 1	< 2	< 2	< 2	2	μΑ
2.5 V	< 1	< 2	< 2	< 2	< 2	μΑ
3.3 V	< 1	< 2	< 2	< 2	< 2	μΑ
5.0 V	< 1	2	< 2	< 2	< 2	μΑ

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14.4 Enable times

Calculate the enable times for the 74LVC2T45-Q100; 74LVCH2T45-Q100 using the following formulas:

- t_{PZH} (DIR to A) = t_{PLZ} (DIR to B) + t_{PLH} (B to A)
- t_{PZL} (DIR to A) = t_{PHZ} (DIR to B) + t_{PHL} (B to A)
- t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B)
- t_{PZL} (DIR to B) = t_{PHZ} (DIR to A) + t_{PHL} (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the 74LVC2T45-Q100; 74LVCH2T45-Q100 initially is transmitting from A to B, then the DIR bit is switched, the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

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15. Package outline

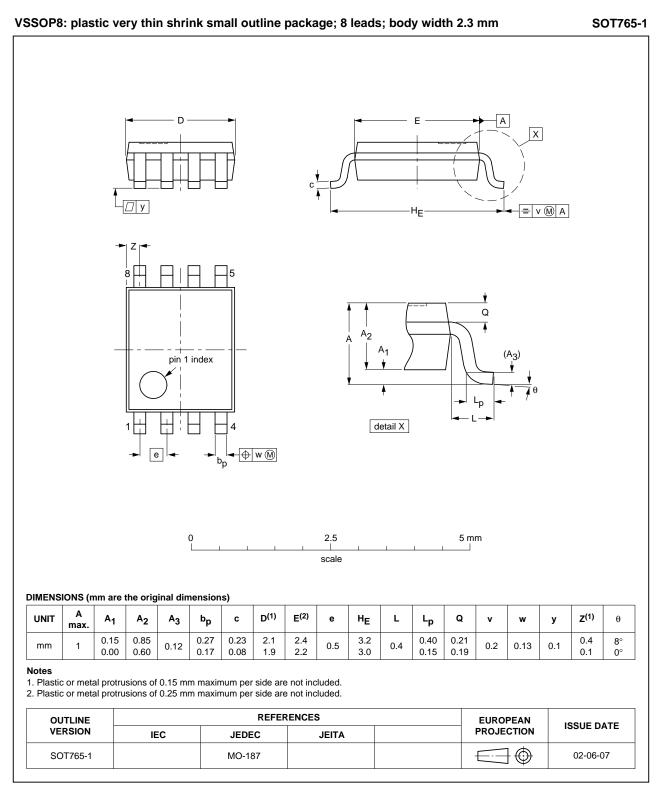


Fig 15. Package outline SOT765-1 (VSSOP8)

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16. Abbreviations

Table 19.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MIL	Military
MM	Machine Model

17. Revision history

Table 20. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH2T45_Q100 v.1	20130222	Product data sheet	-	-

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18. Legal information

18.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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